

RoHS COMPLIANT

QM3006M6-VB Datasheet N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)			
30	0.003 at V _{GS} = 10 V	120	71 nC			
	0.005 at V _{GS} = 4.5 V	90	7110			

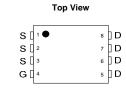
FEATURES

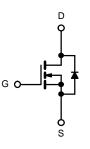
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested •

APPLICATIONS

- Notebook PC Core
- VRM/POL •







N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		120 ^{a, e}	
Continuous Drain Current (T _J = 175 °C)	T _C = 70 °C		90 ^e	
Continuous Drain Current (1) = 175 C)	T _A = 25 °C	I I _D	21 ^{b, c}	A
	T _A = 70 °C		20.8 ^{b, c}	
Pulsed Drain Current		I _{DM} 250		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	56	
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	60	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	80 ^{a, e}	Α
Continuous Source-Drain Diode Current	T _A = 25 °C	'5	76 ^{b, c}	
	T _C = 25 °C		210 ^a	
Maximum Power Dissipation	T _C = 70 °C	P _D	155	w
Maximum Power Dissipation	T _A = 25 °C		35 ^{b, c}	vv
	T _A = 70 °C		13 ^{b, c}	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	$t \le 10 \text{ s}$	R _{thJA}	41	50	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	0.7	0.9	0/10		

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W.
e. Calculated based on maximum junction temperature. Package limitation current is 80 A.

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) Parameter Symbol Test Conditions Min . Typ. Max. Unit								
Symbol	Test Conditions	Min .	Тур.	Max.	Unit			
		1	Т	1	I			
	V _{GS} = 0 V, I _D = 250 μA	30			V			
	I _D = 250 μA				mV/°C			
			- 5.5					
V _{GS(th)}		1.0		2.5	V			
I _{GSS}				± 100	nA			
loco				1	μA			
'D88	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			10				
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	80			A			
P	V _{GS} = 10 V, I _D = 32 A		0.003		Ω			
™DS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 29 \text{ A}$		0.005					
9 _{fs}	V _{DS} = 15 V, I _D = 32 A		130		S			
		•	•					
C _{iss}				3200				
	V _{DS} = 12.5 V, V _{GS} = 0 V, f = 1 MHz			1025	pF			
				970				
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 32 A			71	nC			
Q _g <u>55 55 1</u>				61.5				
Q _{qs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 29 \text{ A}$			34				
				29				
	f = 1 MHz		1.4	2.1	Ω			
•			18	27				
t _r	V _{DD} = 15 V, R _I = 0.555 Ω		11	17	-			
t _{d(off)}	$I_D \cong 27 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$		70	105				
			10	15				
			55	83	ns			
	$V_{DD} = 15 \text{ V. } \text{R}_1 = 0.625 \Omega$		180	270	-			
	55 2		55	83				
				18				
	T _C = 25 °C			80				
	~		1		A			
	I _S = 22 A		0.8		V			
	<u> </u>				ns			
					nC			
	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$			100				
t _a			27		ns			
	Symbol V_{DS} $\Delta V_{DS}/T_J$ $\Delta V_{GS}(th)/T_J$ $V_{GS}(th)/T_J$ $V_{GS}(th)/T_J$ I_{DSS} I_{DSS} I_{DSS} $I_{D(n)}$ $R_{DS(on)}$ gfs C_{iss} C_{oss} C_{rss} Q_g Q_{gd} Q_{gd} $L_{d(on)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r t_{SD} V_{SD} t_{rr} Q_{rr} t_a	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS}(th)/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{DS}(h) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = 4.20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{CS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{Cs} = 15 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{DD} = 15 \ V, \ R_L = 0.555 \ \Omega \\ \hline I_d(on) & I_T & V_{DD} = 15 \ V, \ R_L = 0.625 \ \Omega \\ \hline I_D \cong 27 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 24 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 24 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_D \cong 24 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_F & I_S & I_C = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^\circC $	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min . \\ \hline & & & & & & & & & & & & & & & & & &$	$\begin{array}{ c c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & 35 & 36 & 36 & 36 & 36 & 36 & 36 & 36$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. & Typ. & Max. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 30 & -5.5 &$			

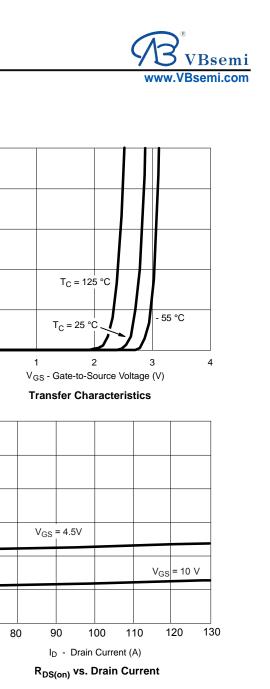
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

VBsemi Bsemi.com



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

3.0

2.4

1.8

1.2

0.6

0.0

0.012

0.010

0.008

0.006

0.004

0.002

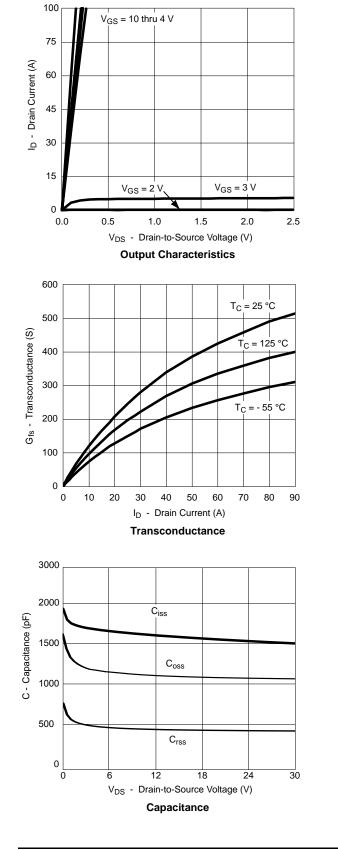
0.000

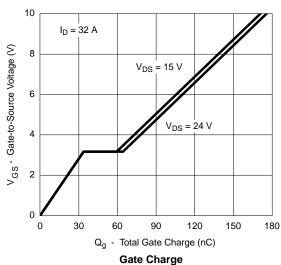
00

 $R_{DS(on)}$ – On-Resistance (Ω)

0

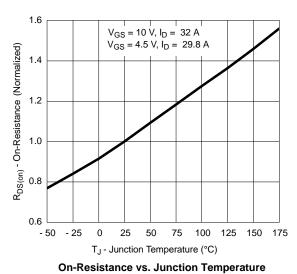
I_D - Drain Current (A)



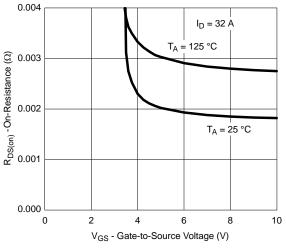


服务热线:400-655-8788

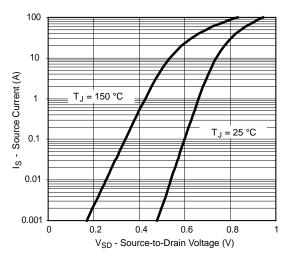




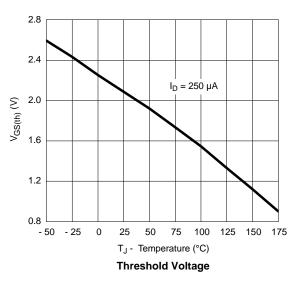
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

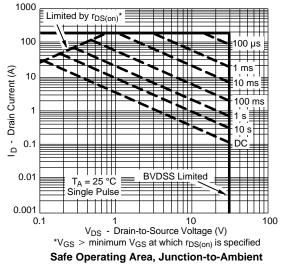


 $R_{\text{DS(on)}}$ vs. V_{GS} vs. Temperature

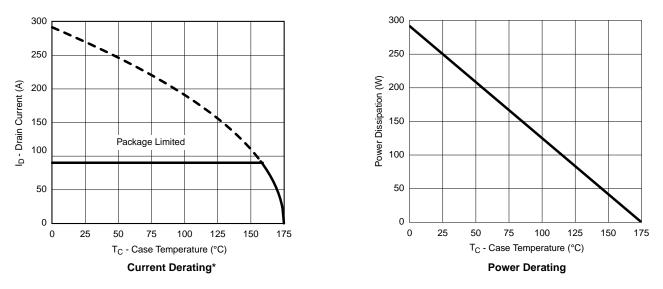


Forward Diode Voltage vs. Temperature



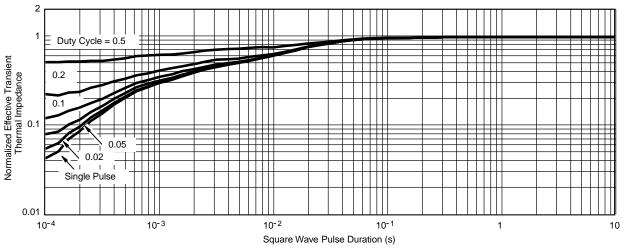






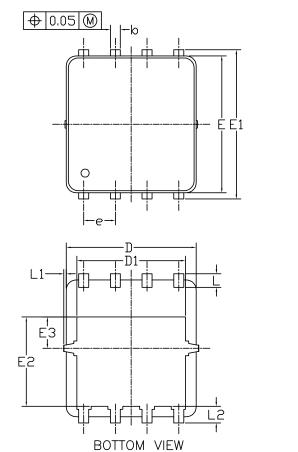
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

* The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

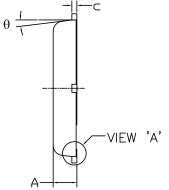


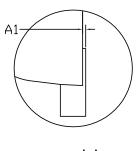
Normalized Thermal Transient Impedance, Junction-to-Case





DFN5x6_8L_EP1_P PACKAGE OUTLIN





<u>VIEW 'A'</u> (SCALE 5:1)

RECOMMENDED LAND PATTERN .60 -0.55 0.50 -0.77 -0.635 4.12 6.15 -1.60 + 0.65 +|+| + ŧ -11.27-0.50-

CNA (DOL 6	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
Al	0.00		0.05	0.000		0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
с	0.15	0.20	0.25	0.006	0.008	0.010
D	5.10	5.20	5.30	0.201	0.205	0.209
D1	4.25	4.35	4.45	0.167	0.171	0.175
Е	5.45	5.55	5.65	0.215	0.219	0.222
E1	5.95	6.05	6.15	0.234	0.238	0.242
E2	3.525	3.625	3.725	0.139	0.143	0.147
E3	1.175	1.275	1.375	0.046	0.050	0.054
e	1.27 BSC				0.050 BSC	
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0		0.15	0		0.006
L2	0.68 REF				0.027 REF	
θ	0°		10°	0°		10°

UNIT: mm

01111.11111

 PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

NOTE



Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

Taiwan VBsemi Electronics Co., Ltd., branches, agents, employees, and all persons acting on its or their representatives (collectively, the "Taiwan VBsemi"), assumes no responsibility for any errors, inaccuracies or incomplete data contained in the table or any other any disclosure of any information related to the product.(www.VBsemi.com)

Taiwan VBsemi makes no guarantee, representation or warranty on the product for any particular purpose of any goods or continuous production. To the maximum extent permitted by applicable law on Taiwan VBsemi relinquished: (1) any application and all liability arising out of or use of any products; (2) any and all liability, including but not limited to special, consequential damages or incidental; (3) any and all implied warranties, including a particular purpose, non-infringement and merchantability guarantee.

Statement on certain types of applications are based on knowledge of the product is often used in a typical application of the general product VBsemi Taiwan demand that the Taiwan VBsemi of. Statement on whether the product is suitable for a particular application is non-binding. It is the customer's responsibility to verify specific product features in the products described in the specification is appropriate for use in a particular application. Parameter data sheets and technical specifications can be provided may vary depending on the application and performance over time. All operating parameters, including typical parameters must be made by customer's technical experts validated for each customer application. Product specifications do not expand or modify Taiwan VBsemi purchasing terms and conditions, including but not limited to warranty herein.

Unless expressly stated in writing, Taiwan VBsemi products are not intended for use in medical, life saving, or life sustaining applications or any other application. Wherein VBsemi product failure could lead to personal injury or death, use or sale of products used in Taiwan VBsemi such applications using client did not express their own risk. Contact your authorized Taiwan VBsemi people who are related to product design applications and other terms and conditions in writing.

The information provided in this document and the company's products without a license, express or implied, by estoppel or otherwise, to any intellectual property rights granted to the VBsemi act or document. Product names and trademarks referred to herein are trademarks of their respective representatives will be all.

Material Category Policy

Taiwan VBsemi Electronics Co., Ltd., hereby certify that all of the products are determined to be RoHS compliant and meets the definition of restrictions under Directive of the European Parliament 2011/65 / EU, 2011 Nian. 6. 8 Ri Yue restrict the use of certain hazardous substances in electrical and electronic equipment (EEE) - modification, unless otherwise specified as inconsistent.(www.VBsemi.com)

Please note that some documents may still refer to Taiwan VBsemi RoHS Directive 2002/95 / EC. We confirm that all products identified as consistent with the Directive 2002/95 / EC European Directive 2011/65 /.

Taiwan VBsemi Electronics Co., Ltd. hereby certify that all of its products comply identified as halogen-free halogen-free standards required by the JEDEC JS709A. Please note that some Taiwanese VBsemi documents still refer to the definition of IEC 61249-2-21, and we are sure that all products conform to confirm compliance with IEC 61249-2-21 standard level JS709A.